

TYPICAL DEVICE CHARACTERISTICS

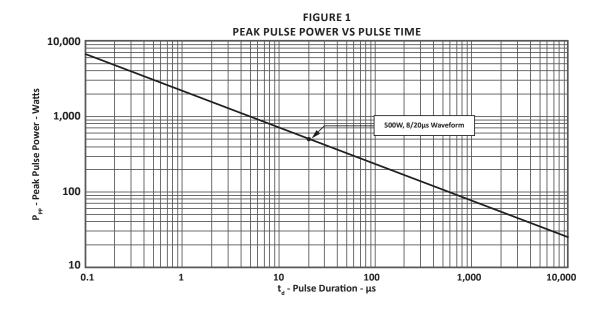
MAXIMUM RATINGS @ 25°C Unless Otherwise Specified							
PARAMETER	VALUE	UNITS					
Operating Temperature	T _L	-55 to 150	°C				
Storage Temperature	T _{stg}	-55 to 150	°C				
Peak Pulse Power (tp = 8/20μs) - See Figure 1	P _{PP}	500	Watts				

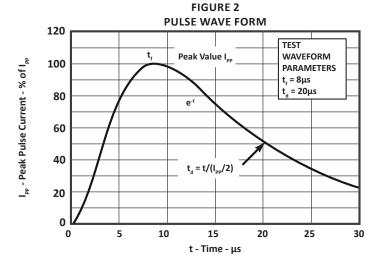
	ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified									
PART NUMBER (Note 1-2)	RATED STAND-OFF VOLTAGE V _{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE @1mA V _(BR) VOLTS	MAXIMUM CLAMPING VOLTAGE (Fig. 2) @Ip = 1A Vc VOLTS	MAXIMUM CLAMPING VOLTAGE (Fig. 2) @8/20μs V _c @ I _{pp}	MAXIMUM LEAKAGE CURRENT @V _{wM} Ι _D μΑ	MAXIMUM CAPACITANCE @0V, 1MHz C pF	TEMPERATURE COEFFICIENT OF V _(BR) qV _(BR) mV/°C			
SM1603	3.3	4.0	7.0	10.9V @ 43A	125	800	-3			
SM1603C	3.3	4.0	7.0	10.9V @ 43A	125	450	-3			
SM1605	5.0	6.0	9.8	13.5V @ 42A	10	550	3			
SM1605C	5.0	6.0	9.8	13.5V @ 42A	10	310	3			
SM1608	8.0	8.5	13.4	16.9V @ 34A	10	500	9			
SM1608C	8.0	8.5	13.4	16.9V @ 34A	10	280	9			
SM1612	12.0	13.3	19.0	25.9V @ 21A	2	185	16			
SM1612C	12.0	13.3	19.0	25.9V @ 21A	2	105	16			
SM1615	15.0	16.7	25.5	30.0V @ 17A	2	140	17			
SM1615C	15.0	16.7	25.5	30.0V @ 17A	2	80	17			
SM1624	24.0	26.7	40.0	49.0V @ 12A	2	88	26			
SM1624C	24.0	26.7	40.0	49.0V @ 12A	2	50	26			

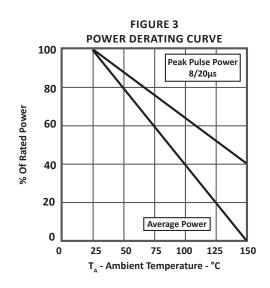
NOTES

- 1. Part numbers with a "C" suffix are bidirectional devices, i.e., SM1615 $\underline{\textbf{C}}$.
- 2. $V_{\rm F}$ = 1.5 Volts @ 100mA, 300 μ s (square wave) unidirectional devices only.

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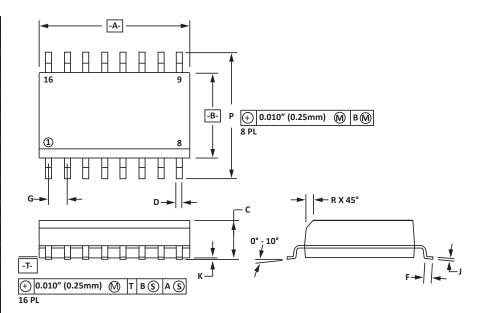


SO-16 PACKAGE INFORMATION

OUTLINE DIMENSIONS								
DIM	MILLIN	METERS	INCHES					
	MIN	MAX	MIN	MAX				
Α	9.80	10.00	0.386	0.393				
В	3.80	4.00	0.150	0.157				
С	1.35	1.35 1.75		0.068				
D	0.35	0.49	0.014	0.019				
F	0.40 1.25		0.016	0.049				
G	1.27	BSC	0.05	BSC				
J	0.18	0.25	0.007	0.009				
К	0.10 0.25		0.004	0.008				
Р	5.80	6.20	0.229	0.244				
R	0.25 0.50		0.010	0.019				

NOTES

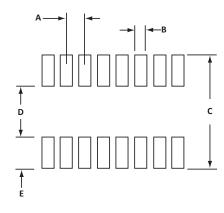
- 1. -T- = Seating plane and datum surface.
- 2. Dimensions "A" and "B" are datum.
- 3. Dimensions "A" and "B" do not include mold protrusion.
- 4. Maximum mold protrusion is 0.015" (0.380mm) per side.
- 5. Dimensioning and tolerances per ANSI Y14.5M, 1982.
- 6. Dimensions are exclusive of mold flash and metal burrs.



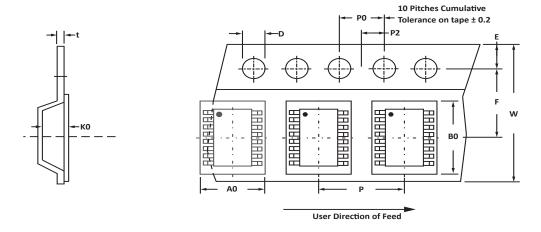
PAD LAYOUT DIMENSIONS								
DIM	MILLIN	METERS	INCHES					
	MIN	MAX	MIN	MAX				
А	1.14	1.40	0.045	0.055				
В	0.64	0.89	0.025	0.035				
С	6.22	-	0.245	-				
D	3.94	4.17	0.155	0.165				
Е	1.02	1.27	0.040	0.050				

NOTES

1. Controlling dimension: inches.



TAPE AND REEL



SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	Α0	В0	ко	D	E	F	w	P0	P2	Р	tmax
178mm (7")	16mm	6.50 ± 0.10	10.30 ± 0.10	2.10 ± 0.10	1.50 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	16.00 ± 0.30	4.00 ± 0.12	2.00 ± 0.10	8.00 ± 0.10	0.25

NOTES

- 1. Dimensions are in millimeters.
- 2. Surface mount product is taped and reeled in accordance with EIA-481.
- 3. Suffix T7 = 7" Reel 1,000 pieces per 16mm tape.
- 4. Suffix T13 = 13" Reel 2,500 pieces per 16mm tape.
- 5. Bulk product shipped in tubes of 48 pieces per tube.
- 6. Marking on Part part number, date code, logo and pin one defined by dot on top of package.

ORDERING INFORMATION									
BASE PART NUMBER (xx = Voltage)	I I FADEREF SUFFIX I TAPE SUFFIX I OTY/REFI I REFI SIZE I TUBE								
SM16xx/SM16xxC	-LF	-T7	1,000	7"	48				
SM16xx/SM16xxC -LF -T13 2,500 13" 48									
This device is only available in a Lead-Free configuration.									

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COMPANY INFORMATION

COMPANY PROFILE

In business more than 25 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is ISO 9001:2015 certified.

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